

MPC7448 Hardware Specifications Addendum for the MC7448xxnnnnNx Series

This document describes part-number-specific changes to recommended operating conditions and revised electrical specifications, as applicable, from those described in the general *MPC7448 RISC Microprocessor Hardware Specifications*. The MPC7448, built on Power Architecture™ technology, implements the PowerPC™ instruction set architecture version 1.0.

Specifications provided in this document supersede those in the *MPC7448 RISC Microprocessor Hardware Specifications*, Rev. 3 or later, for the part numbers listed in [Table A](#) only. Specifications not addressed herein are unchanged. Because this document is frequently updated, refer to the website on the back page of this document or to your Freescale sales office for the latest version.

Note that headings and table numbers in this document are not consecutively numbered. They are intended to correspond to the heading or table affected in the general hardware specification.

Part numbers addressed in this document are listed in [Table A](#).

Freescale Part Numbers Affected:

MC7448HX600Nx	PPC7448HX600Nx
MC7448VS600Nx	PPC7448VS600Nx
MC7448VU600Nx	PPC7448VU600Nx
MC7448HX667Nx	PPC7448HX667Nx
MC7448VS667Nx	PPC7448VS667Nx
MC7448VU667Nx	PPC7448VU667Nx
MC7448HX800Nx	PPC7448HX800Nx
MC7448VS800Nx	PPC7448VS800Nx
MC7448VU800Nx	PPC7448VU800Nx
MC7448HX867Nx	PPC7448HX867Nx
MC7448VS867Nx	PPC7448VS867Nx
MC7448VU867Nx	PPC7448VU867Nx
MC7448HX1000Nx	PPC7448HX1000Nx
MC7448VS1000Nx	PPC7448VS1000Nx
MC7448VU1000Nx	PPC7448VU1000Nx
MC7448HX1250Nx	PPC7448HX1250Nx
MC7448VS1250Nx	PPC7448VS1250Nx
MC7448VU1250Nx	PPC7448VU1250Nx
MC7448HX1267Nx	PPC7448HX1267Nx
MC7448VS1267Nx	PPC7448VS1267Nx
MC7448VU1267Nx	PPC7448VU1267Nx
MC7448HX1400Nx	PPC7448HX1400Nx
MC7448VS1400Nx	PPC7448VS1400Nx
MC7448VU1400Nx	PPC7448VU1400Nx

Table A. Part Numbers Addressed by This Data Sheet

Freescale Part Number	Operating Conditions			Significant Differences from Hardware Specifications
	CPU Frequency (MHz)	V _{DD}	T _j (°C)	
MC7448HX600Nx	600	1.0 V ± 50 mV	0 to 105	Modified core frequency and voltage to reduce power consumption.
MC7448HX667Nx	667	1.0 V ± 50 mV		
MC7448HX800Nx	800	1.0 V ± 50 mV		
MC7448HX867Nx	867	1.0 V ± 50 mV		
MC7448HX1000Nx	1000	1.0 V ± 50 mV		
MC7448HX1250Nx	1250	1.1 V ± 50 mV		
MC7448HX1267NC	1267	1.1 V ± 50 mV		
MC7448HX1267ND	1267	1.05 V ± 50 mV		
MC7448HX1400Nx	1400	1.15 V ± 50 mV ²		
MC7448VS600Nx	600	1.0 V ± 50 mV		
MC7448VS667Nx	667	1.0 V ± 50 mV		
MC7448VS800Nx	800	1.0 V ± 50 mV		
MC7448VS867Nx	867	1.0 V ± 50 mV		
MC7448VS1000Nx	1000	1.0 V ± 50 mV		
MC7448VS1250Nx	1250	1.1 V ± 50 mV		
MC7448VS1267NC	1267	1.1 V ± 50 mV		
MC7448VS1267ND	1267	1.05 V ± 50 mV		
MC7448VS1400Nx	1400	1.15 V ± 50 mV ²		
MC7448VU600Nx	600	1.0 V ± 50 mV		
MC7448VU667Nx	667	1.0 V ± 50 mV		
MC7448VU800Nx	800	1.0 V ± 50 mV		
MC7448VU867Nx	867	1.0 V ± 50 mV		
MC7448VU1000Nx	1000	1.0 V ± 50 mV		
MC7448VU1250Nx	1250	1.1 V ± 50 mV		
MC7448VU1267NC	1267	1.1 V ± 50 mV		
MC7448VU1267ND	1267	1.05 V ± 50 mV		
MC7448VU1400Nx	1400	1.15 V ± 50 mV ²		
PPC7448HX600Nx ¹	600	1.0 V ± 50 mV		
PPC7448HX667Nx ¹	667	1.0 V ± 50 mV		
PPC7448HX800Nx ¹	800	1.0 V ± 50 mV		
PPC7448HX867Nx ¹	867	1.0 V ± 50 mV		
PPC7448HX1000Nx ¹	1000	1.0 V ± 50 mV		
PPC7448HX1250Nx ¹	1250	1.1 V ± 50 mV		
PPC7448HX1267NC ¹	1267	1.1 V ± 50 mV		

Table A. Part Numbers Addressed by This Data Sheet (continued)

Freescale Part Number	Operating Conditions			Significant Differences from Hardware Specifications
	CPU Frequency (MHz)	V _{DD}	T _j (°C)	
PPC7448HX1267ND ¹	1267	1.05 V ± 50 mV	0 to 105	Modified core frequency and voltage to reduce power consumption.
PPC7448HX1400Nx ¹	1400	1.1 V ± 50 mV ²		
PPC7448VS600Nx ¹	600	1.0 V ± 50 mV		
PPC7448VS667Nx ¹	667	1.0 V ± 50 mV		
PPC7448VS800Nx ¹	800	1.0 V ± 50 mV		
PPC7448VS867Nx ¹	867	1.0 V ± 50 mV		
PPC7448VS1000Nx ¹	1000	1.0 V ± 50 mV		
PPC7448VS1250Nx ¹	1250	1.1 V ± 50 mV		
PPC7448VS1267NC ¹	1267	1.1 V ± 50 mV		
PPC7448VS1267ND ¹	1267	1.05 V ± 50 mV		
PPC7448VS1400Nx ¹	1400	1.1 V ± 50 mV ²		
PPC7448VU600Nx ¹	600	1.0 V ± 50 mV		
PPC7448VU667Nx ¹	667	1.0 V ± 50 mV		
PPC7448VU800Nx ¹	800	1.0 V ± 50 mV		
PPC7448VU867Nx ¹	867	1.0 V ± 50 mV		
PPC7448VU1000Nx ¹	1000	1.0 V ± 50 mV		
PPC7448VU1250Nx ¹	1250	1.1 V ± 50 mV		
PPC7448VU1267NC ¹	1267	1.1 V ± 50 mV		
PPC7448VU1267ND ¹	1267	1.05 V ± 50 mV		
PPC7448VU1400Nx ¹	1400	1.1 V ± 50 mV ²		

Notes:

1. The P prefix in a Freescale part number designates a “Pilot Production Prototype” as defined by Freescale SOP 3-13. These parts have only preliminary reliability and characterization data. Before pilot production prototypes can be shipped, written authorization from the customer must be on file in the applicable sales office acknowledging the qualification status and the fact that product changes may still occur as pilot production prototypes are shipped.
2. See [Section 5.1, “DC Electrical Characteristics,”](#) for information regarding V_{DD} specifications for 1400 MHz devices.

4 General Parameters

Core power supply	1.15 V	(1400 MHz devices)
	1.1 V	(1267, 1250 MHz devices)
	1.05 V	(1267 MHz revision level D devices only, See Table 17.)
	1.0 V	(1000, 867, 800, 667, 600 MHz devices)

Note: See [Section 5.1, “DC Electrical Characteristics,”](#) for information regarding V_{DD} specifications for 1400 MHz devices.

5.1 DC Electrical Characteristics

[Table 4](#) provides the recommended operating conditions for the MPC7448 part numbers described here.

NOTE

[Table 4](#) describes the nominal operating conditions of the device. For information on the operation of the device at supported derated core voltage conditions, see [Section 5.3, “Voltage and Frequency Derating.”](#)

Table 4. Recommended Operating Conditions ¹

Characteristic	Symbol	Recommended Value				Unit	Notes
		600 MHz, 667 MHz, 800 MHz, 867 MHz, 1000 MHz	1250 MHz, 1267 MHz ³ Revision Level C for 1267 only	1267 MHz ³ Revision Level D only	1400 MHz ^{3, 4}		
Core supply voltage	V_{DD}	1.0 V \pm 50 mV	1.1 V \pm 50 mV	1.05 V \pm 50 mV	1.15 V \pm 50 mV	V	
PLL supply voltage	AV_{DD}	1.0 V \pm 50 mV	1.1 V \pm 50 mV	1.05 V \pm 50 mV	1.15 V \pm 50 mV	V	2

Notes:

1. These are the recommended and tested operating conditions. Some speed grades in addition support voltage derating; see [Section 5.3, “Voltage and Frequency Derating.”](#) Proper device operation outside of these conditions and those specified in [Section 5.3, “Voltage and Frequency Derating,”](#) is not guaranteed.
2. This voltage is the input to the filter discussed in [Section 9.2.2, “PLL Power Supply Filtering,”](#) in the hardware specifications and not necessarily the voltage at the AV_{DD} pin, which may be reduced from V_{DD} by the filter.
3. V_{DD} and AV_{DD} may be reduced in order to reduce power consumption if further maximum core frequency constraints are observed. See [Section 5.3, “Voltage and Frequency Derating,”](#) for specific information.
4. Effective for 1400 MHz devices with date code of 0613 and later; this includes all devices with the ‘PPC’ product code. V_{DD} and AV_{DD} were specified at 1.1V \pm 50 mV for 1400 MHz devices with date code 0612 and prior. See [Section 11, “Part Numbering and Marking,”](#) for more information.

Table 7 provides the power consumption for the MPC7448 part numbers described by this document; see Section 11.1, “Part Numbers Addressed by This Specification,” for more information. The *MPC7448 RISC Microprocessor Hardware Specifications* presents guidelines on the use of these parameters for system design. For information on power consumption when dynamic frequency switching is enabled, see Section 9.8.5, “Dynamic Frequency Switching (DFS),” in the hardware specifications.

The power consumptions provided in Table 7 represent the power consumption of each speed grade when operated at the rated maximum core frequency (see Table 8). Freescale sorts devices by power as well as by core frequency, and power limits for each speed grade are independent of each other. Each device is tested at its maximum core frequency only. (Note that Deep Sleep Mode power consumption is independent of clock frequency.) Operating a device at a frequency lower than its rated maximum is fully supported provided the clock frequencies are within the specifications given in Table 8, and a device operated at a core frequency below its rated maximum will have lower power consumption. However, inferences should not be made about a device’s power consumption based on the power specifications of another (lower) speed grade. For example, a 1267 MHz device operated at 1000 MHz may not exhibit the same power consumption as a 1000 MHz device operated at 1000 MHz.

NOTE

The power consumption information in this table applies when the device operates at the nominal core voltage indicated in Table 4. For power consumption at derated core voltage conditions, see Section 5.3, “Voltage and Frequency Derating.”

Table 7. Power Consumption for MPC7448 at Maximum Rated Frequency

	Die Junction (T _j) (°C)	Maximum Processor Core Frequency (Speed Grade, MHz)						Unit	Notes
		600, 667	800, 867	1000	1250	1267 ⁷	1400		
Full-Power Mode									
Typical, Nominal	65	8.5	9.0	9.5	10.0	8.4	11.0	W	1, 2
Typical, Thermal	105	10.8	11.4	12.0	12.6	10.3	13.7	W	1, 5
Maximum	105	12.5	13.2	13.9	14.6	12.0	15.9	W	1, 3
Nap Mode									
Typical	105	6.5	6.5	6.5	8.3	6.5	8.3	W	1, 6
Sleep Mode									
Typical	105	6.3	6.3	6.3	8.0	6.3	8.0	W	1, 6
Deep Sleep Mode (PLL Disabled)									
Typical	105	6.0	6.0	6.0	7.7	6.0	7.7	W	1, 6

Notes:

1. These values specify the power consumption for the core power supply (V_{DD}) at nominal voltage and apply to all valid processor bus frequencies and configurations. The values do not include I/O supply power (OV_{DD}) or PLL supply power (AV_{DD}). OV_{DD} power is system dependent but is typically < 5% of V_{DD} power. Worst case power consumption for AV_{DD} < 13 mW.
2. Typical nominal power consumption is an average value measured at the nominal recommended V_{DD} (see Table 4) and 65°C while running the Dhrystone 2.1 benchmark and achieving 2.3 Dhrystone MIPs/MHz. This parameter is not 100% tested but periodically sampled.
3. Maximum power consumption is the average measured at nominal V_{DD} and maximum operating junction temperature (see Table 4) while running an entirely cache-resident, contrived sequence of instructions to keep all the execution units maximally busy.
4. Doze mode is not a user-definable state; it is an intermediate state between full-power and either nap or sleep mode. As a result, power consumption for this mode is not tested.
5. Typical thermal power consumption is an average value measured at the nominal recommended V_{DD} (see Table 4) and 105°C while running the Dhrystone 2.1 benchmark and achieving 2.3 Dhrystone MIPs/MHz. This parameter is not 100% tested but periodically sampled.
6. Typical power consumption for these modes is measured at the nominal recommended V_{DD} (see Table 4) and 105°C in the mode described. This parameter is not 100% tested but is periodically sampled.
7. Power consumption for the 1267 MHz device is intentionally constrained via testing and sorting to assure low power consumption for this device.

5.2.1 Clock AC Specifications

Table 8 provides the clock AC timing specifications for the MPC7448 part numbers discussed here.

NOTE

The core frequency information in this table applies when the device operates at the nominal core voltage indicated in Table 4. For core frequency specifications at derated core voltage conditions, see Section 5.3, “Voltage and Frequency Derating.”

Table 8. Clock AC Timing Specifications

At recommended operating conditions. See Table 4.

Characteristic	Symbol	Maximum Processor Core Frequency (MHz)																Unit	Notes
		600		667		800		867		1000		1250		1267		1400			
		Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max		
Processor frequency DFS mode disabled	f_{core}	500	600	500	667	500	800	500	867	500	1000	500	1250	500	1267	500	1400	MHz	1, 8, 9
Processor frequency DFS mode enabled	$f_{\text{core-DFS}}$	250	300	250	333	250	400	250	433	250	500	250	625	250	633	250	700	MHz	10
VCO frequency	f_{VCO}	500	600	500	667	500	800	500	867	500	1000	500	1250	500	1267	500	1400	MHz	1, 9

Notes:

- Caution:** The SYSCLK frequency and PLL_CFG[0:5] settings must be chosen such that the resulting SYSCLK (bus) frequency, processor core frequency, and PLL (VCO) frequency do not exceed their respective maximum or minimum operating frequencies. Refer to the PLL_CFG[0:5] signal description in Section 9.1.1, “PLL Configuration,” in the hardware specifications for valid PLL_CFG[0:5] settings.
- This reflects the maximum and minimum core frequencies when the dynamic frequency switching feature (DFS) is disabled. $f_{\text{core_DFS}}$ provides the maximum and minimum core frequencies in a DFS mode.
- Caution:** These values specify the maximum processor core and VCO frequencies when the device is operated at the nominal core voltage. If operating the device at the derated core voltage, the processor core and VCO frequencies must be reduced. See Section 5.3, “Voltage and Frequency Derating,” for more information.
- This specification supports the Dynamic Frequency Switching (DFS) feature and is applicable only when one of the DFS modes (divide-by-2 or divide-by-4) is enabled. When DFS is disabled, the core frequency must conform to the maximum and minimum frequencies stated for f_{core} .

5.3 Voltage and Frequency Derating

To reduce power consumption, these devices support voltage and frequency derating in which the core voltage (V_{DD}) may be reduced if the reduced maximum processor core frequency requirements are observed. The supported derated core voltage, resulting maximum processor core frequency (f_{core}), and power consumption are provided in Table 11. Only those parameters in Table 11 are affected; all other parameter specifications are unaffected.

Table 11. Supported Voltage, Core Frequency, and Power Consumption Derating

Maximum Rated Core Frequency (Device Marking)	Supported Derated Core Voltage (V_{DD})	Maximum Derated Core Frequency (f_{core})	Full-Power Mode Power Consumption		
			Typical	Thermal	Maximum
600			N/A		
667			N/A		
800			N/A		
867			N/A		
1000			N/A		
1250			N/A		
1267	1.0 V \pm 50 mV	1000 MHz	6.0 W	7.3 W	8.5 W
1400	1.0 V \pm 50 mV	1000 MHz	8.0 W	9.9 W	11.5 W

9.2 Power Supply Design and Sequencing

The power supply design and sequencing requirements of the devices described here are identical to those described in the *MPC7448 RISC Microprocessor Hardware Specifications*.

11 Part Numbering and Marking

11.1 Part Numbers Addressed by This Specification

Table 17 provides the ordering information for the MPC7448 parts described in this document.

Table 17. Part Marking Nomenclature

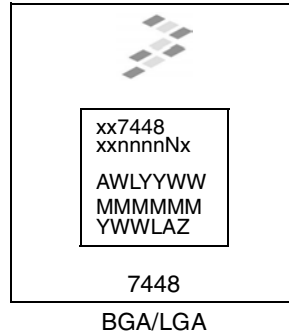
xx	7448	xx	nnnn	N	x
Product Code	Part Identifier	Package	Processor Frequency	Application Modifier	Revision Level
MC PPC ¹	7448	HX = HCTE BGA VS = RoHS LGA VU = RoHS BGA	600 667 800 867 1000	N: 1.0 V ± 50 mV 0 to 105°C	C:2.1: PVR = 0x8004_0201 D:2.2: PVR = 0x8004_0202
			1250	N: 1.1 V ± 50 mV 0 to 105°C	
MC PPC ¹			1267 Revision C only	N: 1.1 V ± 50 mV 0 to 105°C	
MC PPC ¹			1267 Revision D only	N: 1.05 V ± 50 mV 0 to 105°C	
MC			1400	N: 1.15 V ± 50 mV 0 to 105°C (date code 0613 and later) ²	
MC PPC ¹			1400	N: 1.1 V ± 50 mV 0 to 105°C (date code 0612 and prior) ²	

Notes:

1. The P prefix in a Freescale part number designates a “Pilot Production Prototype” as defined by Freescale SOP 3-13. These parts have only preliminary reliability and characterization data. Before pilot production prototypes can be shipped, written authorization from the customer must be on file in the applicable sales office acknowledging the qualification status and the fact that product changes may still occur as pilot production prototypes are shipped.
2. Core voltage for 1400 MHz devices currently in production (date code of 0613 and later) is 1.15 V ± 50 mV; all such devices have the MC product code. The 1400 MHz devices with date code of 0612 and prior specified core voltage of 1.1 V ± 50 mV; this includes all 1400 MHz devices with the PPC product code. See [Section 11.3, “Part Marking,”](#) for information on part marking.

11.3 Part Marking

Parts are marked as the example shown in [Figure 23](#).



Notes:

AWLYYWW is the test code, where YYWW is the date code (YY = year, WW = work week)

MMMMMM is the M00 (mask) number.

YWWLAZ is the assembly traceability code.

Figure 23. Part Marking for BGA/LGA Device

Document Revision History

Table B provides a revision history for this part number specification.

Table B. Document Revision History

Revision	Date	Substantive Change(s)
6	3/2007	<p>Added MC7448HX800Nx, MC7448VS800Nx, MC7448VU800Nx, PPC7448HX800Nx, PPC7448VS800Nx, and PPC7448VU800Nx to the first page list of Freescale Part Numbers Affected.</p> <p>Table A: Added MC7448HX800Nx, MC7448VS800Nx, MC7448VU800Nx, PPC7448HX800Nx, PPC7448VS800Nx, and PPC7448VU800Nx rows.</p> <p>Section 4, "General Parameters": Added 800 MHz information.</p> <p>Table 4: Added 800 MHz to the 600 - 1000 MHz column.</p> <p>Table 7: Combined 600 MHz and 667 MHz columns (same specifications); added 800 MHz to 867 MHz column (same specifications).</p> <p>Table 8: Added 800 MHz column with associated specifications.</p> <p>Table 11: Added 800 MHz row.</p> <p>Table 17: Added 800 MHz to the 600 - 1000 MHz Processor Frequency cell.</p>
5	10/2006	<p>Added revision level D device information.</p> <p>Table A and in list of Freescale Part Numbers Affected on first page: x stands for C or D revision level.</p> <p>Added PPC7448HX1267Nx, PPC7448VS1267Nx, and PPC7448VU1267Nx to the first page list of Freescale Part Numbers Affected.</p> <p>Table A: Added PPC7448HX1267NC, PPC7448HX1267ND, PPC7448VS1267NC, PPC7448VS1267ND, PPC7448VU1267NC, and PPC7448VU1267ND rows.</p> <p>Section 4, "General Parameters": Added 1267 MHz revision level D information.</p> <p>Table 4: Added 1267 MHz revision D only column.</p> <p>Table 17: Removed specification modifier 'T' column.</p> <p>Table 17: Added PVR and 1267 information for revision level D.</p> <p>Figure 23: Removed 'T' from part numbering.</p>
4	6/2006	Added support for voltage and frequency derating for 1267 MHz devices.
3	4/2006	<p>Added 1267 MHz device.</p> <p>Increased V_{DD} and AV_{DD} specifications for 1400 MHz devices with date code 0613 and later.</p>
2	1/2006	Table 7: Corrected processor frequency from 867 MHz to 667 MHz (867 MHz appeared twice) so that top row shows 600 MHz, 667 MHz, 867 MHz, 1000 MHz, 1250 MHz, 1400 MHz.
1	12/2005	<p>Table 7: Added power specifications for low power modes and for Typical – Thermal condition, changed name of "Typical" power specification to "Typical – Nominal".</p> <p>Table 8: Added minimum core frequency and DFS mode frequency information.</p> <p>Table 11: Added voltage derating information for 1400 MHz devices; this feature is not supported at this time for other speed grades.</p> <p>Added Section 9.3 (for clarification only).</p> <p>Table 17: Corrected part revision information, added "PPC" product code prefix.</p>
0	9/2005	Initial release.

How to Reach Us:

Home Page:

www.freescale.com

email:

support@freescale.com

USA/Europe or Locations Not Listed:

Freescale Semiconductor
Technical Information Center, CH370
1300 N. Alma School Road
Chandler, Arizona 85224
1-800-521-6274
480-768-2130
support@freescale.com

Europe, Middle East, and Africa:

Freescale Halbleiter Deutschland GmbH
Technical Information Center
Schatzbogen 7
81829 Muenchen, Germany
+44 1296 380 456 (English)
+46 8 52200080 (English)
+49 89 92103 559 (German)
+33 1 69 35 48 48 (French)
support@freescale.com

Japan:

Freescale Semiconductor Japan Ltd.
Headquarters
ARCO Tower 15F
1-8-1, Shimo-Meguro, Meguro-ku
Tokyo 153-0064, Japan
0120 191014
+81 3 5437 9125
support.japan@freescale.com

Asia/Pacific:

Freescale Semiconductor Hong Kong Ltd.
Technical Information Center
2 Dai King Street
Tai Po Industrial Estate,
Tai Po, N.T., Hong Kong
+800 2666 8080
support.asia@freescale.com

For Literature Requests Only:

Freescale Semiconductor
Literature Distribution Center
P.O. Box 5405
Denver, Colorado 80217
1-800-441-2447
303-675-2140
Fax: 303-675-2150
LDCForFreescaleSemiconductor
@hibbertgroup.com

Information in this document is provided solely to enable system and software implementers to use Freescale Semiconductor products. There are no express or implied copyright licenses granted hereunder to design or fabricate any integrated circuits or integrated circuits based on the information in this document.

Freescale Semiconductor reserves the right to make changes without further notice to any products herein. Freescale Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Freescale Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters which may be provided in Freescale Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. Freescale Semiconductor does not convey any license under its patent rights nor the rights of others. Freescale Semiconductor products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Freescale Semiconductor product could create a situation where personal injury or death may occur. Should Buyer purchase or use Freescale Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold Freescale Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Freescale Semiconductor was negligent regarding the design or manufacture of the part.

Freescale™ and the Freescale logo are trademarks of Freescale Semiconductor, Inc. The Power Architecture and Power.org word marks and the Power and Power.org logos and related marks are trademarks and service marks licensed by Power.org. The described product is a PowerPC microprocessor. The PowerPC name is a trademark of IBM Corp. and is used under license. All other product or service names are the property of their respective owners.

© Freescale Semiconductor, Inc., 2005, 2007.

Document Number: MPC7448ECS01AD

Rev. 6
3/2007



KMC7448VU1700LD Information

[General information](#)
[Package information](#)
[Environmental and Compliance information](#)
[Manufacturing and Qualification information](#)
[Ordering information](#)
[Product/Process Change Notice \(PCN\)](#)


General Information

Parameter	Value
Part Number	KMC7448VU1700LD
Description	APL8,RV2.2.1,1.3V,105C
Material Type	Tested Packaged Device
Life Cycle Description (code)	PRODUCT NEWLY INTRO D/RAMP-UP(1)
Status	Active

Package Information

Parameter	Value
Package Description	FCCBGA 360 25SQ*2.2P1.27
JEDEC Pkg Description	CBGA-B360
Pin/Lead/Ball Count	360
Package Material	Ceramic
Mounting Style	Surface Mount
Tape & Reel	No

Environmental and Compliance Information

Parameter	Value
Pb-Free	No
RoHS Compliant	
Halogen Free	Yes
Product Content Report	Product Content Report
2nd Level Interconnect	e1
Moisture Sensitivity Level (MSL)	1
Floor Life	UNLIMITED
Package Peak Temperature (°C)	260

Manufacturing and Qualification information

Parameter	Value
Micron Size (µm)	.09

Ordering Information

Parameter	Value
Last Order Date	
Last Ship Date	
Minimum Package Quantity (MPQ)	1
MPQ Container	TRAY
Preferred Order Quantity (POQ)	2
POQ Container	BOX
Leadtime (weeks)	
Export Control Classification Number (US)	3A991
Harmonized Tariff (US) disclaimer	8542.31.0000
Budgetary Price QTY 1000+ (\$US)	-
Order	Distributor

Product/Process Change Notice (PCN)

Number	Type	Title	Issue Date	Effectivity Date
12712	Product Change Notice	MC7448 SECOND SOURCE C4 BUMP PROCESSING	20 Jun 2007	18 Sep 2007